# Panasonic ideas for life

#### 1.8 GHZ HIGH FREQUENCY, 4 mm LOW PROFILE RELAY

## RP RELAYS



#### **FEATURES**

- 1. High frequency relay with the low profile of 4 mm .157 inch
- 2. Excellent high frequency characteristics
- Isolation: Min. 10dB (at 1.8 GHz)
- Insertion loss: Max. 1.0dB (at 1.8 GHz)
- V.S.W.R.: Max. 1.3 (at 1.8 GHz)
- 3. High sensitivity in small size

Size:  $10.6 \times 9 \times 4 \text{ mm}$ 

 $.417 \times .354 \times .157$  inch Nominal operating power: 140 mW

4. Utilizes tube package for automatic mounting.

5. Self-clinching terminal also available

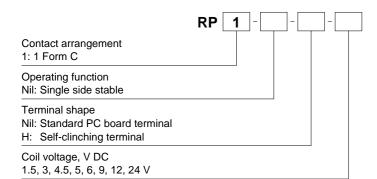
#### TYPICAL APPLICATIONS

- Switching signal of measuring equipment
- All types of compact wireless devices

If you wish to use in applications with low level loads or with high frequency switching, please consult us.

RoHS compliant

## ORDERING INFORMATION



#### **TYPES**

Contact arrangement		Standard PC board terminal		
	Nominal coil voltage	Single side stable	Self-clinching terminal Single side stable	
		Part No.	Part No.	
1 Form C	1.5V DC	RP1-1.5V	RP1-H-1.5V	
	3 V DC	RP1-3V	RP1-H-3V	
	4.5V DC	RP1-4.5V	RP1-H-4.5V	
	5 V DC	RP1-5V	RP1-H-5V	
	6 V DC	RP1-6V	RP1-H-6V	
	9 V DC	RP1-9V	RP1-H-9V	
	12 V DC	RP1-12V	RP1-H-12V	
	24 V DC	RP1-24V	RP1-H-24V	

Standard packing: 50 pcs. in an inner package (tube); 1,000 pcs. in an outer package

#### **RATING**

#### 1. Coil data

Nominal coil voltage	Pick-up voltage (at 20°C 68°F)	Drop-out voltage (at 20°C 68°F)	Nominal operating current [±10%] (at 20°C 68°F)	Coil resistance [±10%] (at 20°C 68°F)	Nominal operating power	Max. applied voltage (at 20°C 68°F)
1.5V DC			93.8mA	16 Ω	140mW	150%V of nominal voltage
3 V DC			46.7mA	64.3Ω		
4.5V DC			31.0mA	145 Ω		
5 V DC		75%V or less of nominal voltage* (Initial) 10%V or more of nominal voltage* (Initial)	28.1mA	178 Ω		
6 V DC			23.3mA	257 Ω		
9 V DC	(,		15.5mA	579 Ω		
12 V DC			11.7mA	1,028 Ω		
24 V DC			11.3mA	2,133 Ω	270mW	120%V of nominal voltage

<sup>\*</sup>Pulse drive (JIS C5442)

#### 2. Specifications

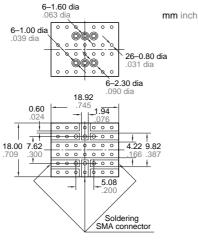
Characteristics	Item		Specifications	
	Arrangement		1 Form C	
Contact	Initial contact resistance, max.		Max.50mΩ (By voltage drop 6V DC 0.1A)	
	Contact material		Stationary: Ag + Au clad, Movable: AgPd	
Rating	Contact rating		0.1A 30V DC (resistive load); Contact carrying power: 3W (Max. 1.2GHz); 1W (Max. 1.8GHz); Contact switching power: 1W (Max. 1.8GHz)	
	Nominal operating power (single side stable type)		140mW (1.5 to 12V DC), 270mW (24V DC)	
High frequency	V.S.W.R.		Max. 1.2 (at 1GHz), Max. 1.3 (at 1.8GHz)	
characteristics (Initial)	Insertion loss (without D.U.T. board's loss)		Max. 0.5dB (at 1GHz), Max. 1dB (at 1.8GHz)	
(Impedance $50\Omega$ )	Isolation		Min. 15dB (at 1GHz), Min. 10dB (at 1.8GHz)	
	Insulation resistance (Initial)		Min. 1,000MΩ (at 500V DC) Measurement at same location as "Initial breakdown voltage" section.	
	Breakdown voltage (Initial)	Between open contacts	750 Vrms for 1min. (Detection current: 10mA)	
		Between contact and coil	1,500 Vrms for 1min. (Detection current: 10mA)	
Electrical characteristics	Temperature rise (at 20°C)		Max. 50°C (By resistive method, nominal voltage applied to the coil, contact carrying power: 1W/at 1.8GHz)	
	Operate time (at 20°C)		Max. 3ms (Approx. 1.5ms) (Nominal operating voltage applied to the coil, excluding contact bounce time.)	
	Release time (at 20°C)		Max. 2ms (Approx. 1ms) (Nominal operating voltage applied to the coil, excluding contact bounce time.) (without diode)	
	Shock resistance	Functional	Min. 500 m/s <sup>2</sup> {Approx. 50G} (Half-wave pulse of sine wave: 11ms; detection time: 10μs.)	
Mechanical		Destructive	Min. 1,000 m/s² {Approx. 100G} (Half-wave pulse of sine wave: 6ms.)	
characteristics	Vibration	Functional	10 to 55 Hz at double amplitude of 3mm (Detection time: 10μs.)	
	resistance	Destructive	10 to 55 Hz at double amplitude of 5mm	
Expected life	Mechanical		Min. 5×10 <sup>6</sup> (at 180 cpm)	
Expected life	Electrical		Min. 10 <sup>5</sup> (0.1A 30V DC resistive load, 1W (at 1.8GHz, V.S.W.R. max. 1.3 at 20 cpm)	
Conditions	Conditions for operation, transport and storage*		Ambient temperature: -40°C to +70°C -40°F to +158°F Humidity: 5 to 85% R.H. (Not freezing and condensing at low temperature)	
	Max. operating speed (at rated load)		20 cpm (at rated load)	
Unit weight			Approx. 1 g .04 oz	

Note: \* The upper operation ambient temperature limit is the maximum temperature that can satisfy the coil temperature rise value. Refer to [6] AMBIENT ENVIRONMENT in GENERAL APPLICATION GUIDELINES.

#### **REFERENCE DATA**

1. High frequency characteristics Sample: RP1-6V

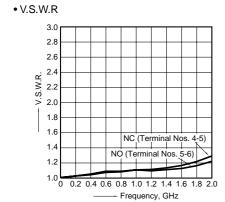
Measuring method: Impedance  $50\Omega$  Measuring tool:

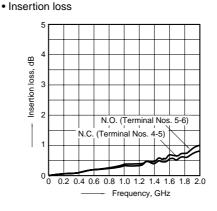


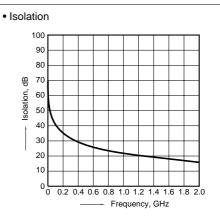
#### PC board

- Double-sided through hole
  Material: Glass-epoxy resin
  t = 1.0mm .039 inch

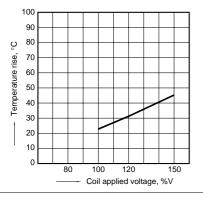
- Copper plated thickness: 35 μm





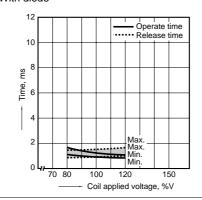


2. Coil temperature rise Sample: RP1-6V; No. of samples: n = 5 Carrying current: 0.1 A Ambient temperature: 25°C 77°F

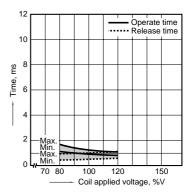


3. Operate/release time Sample: RP1-9V; No. of samples: n = 50

With diode

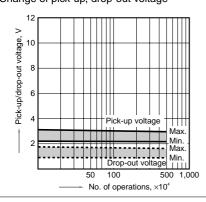


Without diode



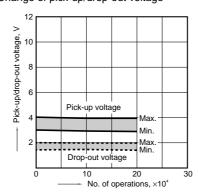
4. Mechanical life Sample: RP1-5V; No. of samples: n = 8

• Change of pick-up, drop-out voltage

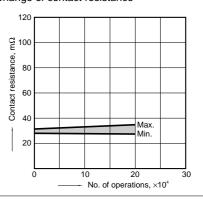


5. Electrical life (0.1 A 30 V DC) Sample: RP1-6V; No. of samples: n = 6

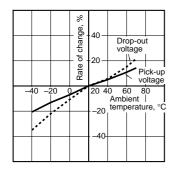
• Change of pick-up/drop-out voltage



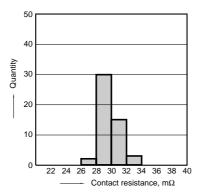
• Change of contact resistance



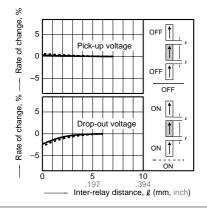
6. Ambient temperature characteristics Sample: RP1-6V; No. of samples: n = 5



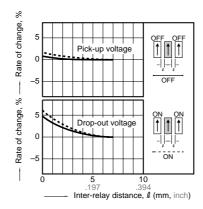
7. Contact resistance distribution (initial) Sample: RP1-12V; No. of samples: n = 25



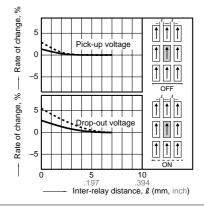
8.-(1) Influence of adjacent mounting Sample: RP1-12V; No. of samples: n = 6



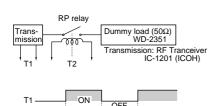
8.-(2) Influence of adjacent mounting Sample: RP1-12V; No. of samples: n = 6



8.-(3) Influence of adjacent mounting Sample: RP1-12V; No. of samples: n = 6



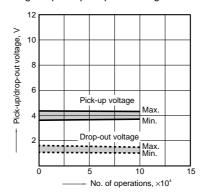
9. High frequency switching test (1.2 GHz, 1 W) Sample: RP1-6V; No. of samples: n = 6 Ambient temperature:  $20^{\circ}C$   $68^{\circ}F$ 



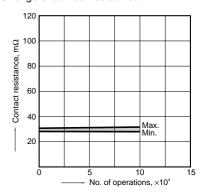
- 0.2s

- 1.5s

#### • Change of pick-up/drop-out voltage



#### • Change of contact resistance



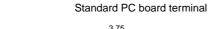
**DIMENSIONS** (mm inch)

--- 1.5s -

The CAD data of the products with a CAD Data mark can be downloaded from: http://industrial.panasonic.com/ac/e

CAD Data

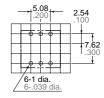
0.2s ---



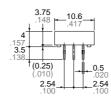




PC board pattern (Bottom view)



Self-clinching terminal





Tolerance: ±0.1 ±.004 Schematic (Bottom view)



Deenergized condition

#### **NOTES**

#### 1. Coil operating power

Pure DC current should be applied to the coil. The wave form should be rectangular. If it includes ripple, the ripple factor should be less than 5%.

However, check it with the actual circuit since the characteristics may be slightly different. The nominal operating voltage should be applied to the coil for more than 20 ms to set/reset the latching type relay.

#### 2. Coil connection

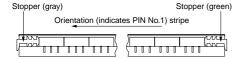
When connecting coils, refer to the wiring diagram to prevent mis-operation or malfunction.

#### 3. External magnetic field

Since RP relays are highly sensitive polarized relays, their characteristics will be affected by a strong external magnetic field. Avoid using the relay under that condition.

#### 4. Packing direction

Relays are packed in a tube with the orientation stripe (PIN NO. 1) toward the green stopper.



#### 5. Automatic mounting

To maintain the internal function of the relay, the chucking pressure should not exceed the values below.

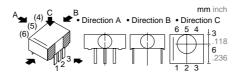
Chucking pressure\* in the direction A: 4.9 N {500 gf} or less

Chucking pressure\* in the direction B: 9.8 N {1 kgf} or less

Chucking pressure\* in the direction C: 9.8 N {1 kgf} or less

Please chuck the portion.

Avoid chucking the center of the relay. In addition, excessive chucking pressure to the pinpoint of the relay should be avoided.



\*Value of chucking pressure is shown by the value of weight pressed on the portion (4 mm .157 inch dia.).

#### 6. Soldering

Preheat according to the following conditions.

Temperature	120°C 248°F or less
Time	Within 2 minute

Soldering should be done at 260±5°C 500±9°F within 6 s.

For general cautions for use, please refer to the "General Application Guidelines".

## **Mouser Electronics**

**Authorized Distributor** 

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### Panasonic:

<u>RP1-1.5V RP1-24V RP1-3V RP1-4.5V RP1-6V RP1-6V RP1-9V RP1-H-5V RP1-H-24V RP1-H-24V RP1-H-3V RP1-H-3V RP1-H-5V RP1-H-5V RP1-H-6V RP1-H-9V RP1-5V RP1-12V RP1-H-24V RP1-H-24V RP1-H-3V R</u>